

# Schottky-Contacted WSe<sub>2</sub> Hot-Electron Photodetectors with Fast Response and High Sensitivity

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detectors demonstrated a high rectification ratio of  $10^7$  and an extremely low dark current of 1 pA/ $\mu$ m with a high  $I_{\text{light}}/I_{\text{dark}}$  ratio of  $1.8 \times 10^6$ . Moreover, a high responsivity of 3.69 A/W and detectivity of 2.39  $\times 10^{13}$  Jones at an incident light power of 5.0  $\mu$ W/cm<sup>2</sup> are simultaneously achieved. The present strategy offers an alternative route for ultrasensitive photodetectors with fast response.

**KEYWORDS:** hot-electron, tunneling, Schottky contact, built-in field, photodetector

#### INTRODUCTION

Low-power photodetectors with fast response and high sensitivity are urgent for both scientific and industrial applications.<sup>1-3</sup> Two-dimensional (2D) materials show potential as channel materials in optoelectronic devices due to their strong interaction with incident light.<sup>4–6</sup> However, 2D material-based photodetectors typically exhibit low response speed and persistent current because of unintentionally introduced traps in ultrathin 2D channels as well as the long lifetime of trapped carriers.<sup>7-9</sup> To address these issues for ultrasensitive and fast-response applications, photoinduced carriers should be efficiently separated and thereafter collected by rationally designing the device structure. Hot electrons can be excited in metal by photon absorption with energy above the Fermi level of metal, which is beneficial for fabricating photodetectors. Hot-electron photodetectors (HEPs) rely on photoinjected hot electrons excited through photon absorption and extracted via internal photoemission with the intriguing prospect of direct below-bandgap photodetection.<sup>8,10</sup> It is worth pointing out that the lifetime of hot electrons is extremely short, wherein the thermal relaxation processes are accomplished in less than several picoseconds. In this case, hot electrons should be collected or extracted (i.e., charge transfer) on the same timescale before they lose their excess energy. The built-in field in Schottky junctions could efficiently separate the photoinduced electron-hole pairs. Therefore, hot-carrier photodetectors with Schottky contact can offer ultrasensitive and fast detection of incident light. Also, the hot electrons injected from the metal into an adjacent semiconductor across a tunneling barrier can further reduce the dark current. In addition, monochromatic hot electrons with high kinetic energy traverse across the energy barrier, creating a photocurrent that enables the detection of incident light with energy below the bandgap of semiconductors. Therefore, HEPs can afford ultrahigh sensitivity under weak incident light with wide detective spectral regions.

In this work, ultrasensitive fast-response WSe<sub>2</sub> HEPs with Schottky contact are demonstrated. Benefiting from the ultrathin thickness (5 nm) of the Al<sub>2</sub>O<sub>3</sub> insulating layer, the dark current is suppressed by the barrier at the Cr/Al<sub>2</sub>O<sub>3</sub>/ WSe<sub>2</sub> junction.<sup>11</sup> Under light illumination, the photocurrent is generated by the photoinduced carriers across the Al<sub>2</sub>O<sub>3</sub> tunneling layer. The emission energy of hot electrons is observably increased, and the carrier transport time is greatly reduced.<sup>8</sup> Electrical transport measurements indicate a high rectification ratio of 10<sup>7</sup>. A high photoresponsivity (*R*) of 3.69 A/W, high detectivity (*D*\*) of 2.39 × 10<sup>13</sup> Jones at an incident light power density (*P*<sub>light</sub>) of 5.0  $\mu$ W/cm<sup>2</sup>, and an *I*<sub>light</sub>/*I*<sub>dark</sub> ratio of 1.8 × 10<sup>6</sup> are obtained in the WSe<sub>2</sub> HEPs.

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Figure 1. Schematic images of the  $WSe_2$  hot-electron photodetectors (HEPs). (a-c) Fabrication processes of  $WSe_2$  HEPs. (d) Band alignment of the device under forward bias. (e) Band diagram of the device under reverse bias. (f) Height profile across the  $WSe_2$  HEPs and the inset is the AFM image.



**Figure 2.** Electrical performance of the WSe<sub>2</sub> hot-electron diodes. (a) Optical image of the WSe<sub>2</sub> hot-electron diodes. The scale bar is 20  $\mu$ m. The width and length of the devices are 2.3 and 2  $\mu$ m, respectively. (b) Transfer characteristics of WSe<sub>2</sub> hot-electron devices. (c) Transfer curve comparison of the multilayer WSe<sub>2</sub> transistors with different contacts. (d) Output characteristics of WSe<sub>2</sub> hot-electron device at various gate voltages. The corresponding linear plots are shown in the inset. (e) Extracted currents RR in the dark as a function of  $V_{DS}$ . (f) Output voltage waveform obtained from an input sine waveform at 100 Hz.

# RESULTS AND DISCUSSION

Figure 1a-c shows the schematic illustrating the fabrication of the WSe<sub>2</sub> hot-electron device with asymmetric contact. First, Cr/Au (15 nm/50 nm) electrodes are defined on a silicon substrate (with 300 nm  $SiO_2$ ) by photolithography, and then metal evaporation and lift-off processes are introduced. WSe<sub>2</sub> flakes are obtained by mechanical exfoliation with Scotch tape<sup>12</sup> and then transferred onto the Au electrode to form ideal Schottky contact without the pinning effect.<sup>13</sup> Subsequently, a 5 nm Al<sub>2</sub>O<sub>3</sub> tunneling layer is grown by atomic layer deposition. The top electrode region is patterned by e-beam lithography (EBL), and thermal evaporation is used to deposit Cr/Au (15 nm/50 nm) electrodes. The band alignment of WSe<sub>2</sub> hot-electron devices is shown in Figure 1d under forward bias. The ultrathin  $Al_2O_3$  dielectric acts as the tunneling layer for carrier injection and screens the homochromous highenergy hot electrons.<sup>14</sup> Under forward bias, the Au/WSe<sub>2</sub> Schottky barrier height is reduced, leading to high photocurrent.<sup>15</sup> Figure 1e shows the band diagram under reverse bias. In this case, the depletion width of the Schottky barrier is

significantly enlarged. By inserting an  $Al_2O_3$  insulating layer, reverse leakage current is highly suppressed as well. Under reverse-biased conditions, the strength of the net electric-field of the device is enhanced, which comparatively accelerate the separation of photoinduced carriers. Atomic force microscopy (AFM) is employed to measure the height profile information, as shown in Figure 1f and the inset, which indicates the height profile across the WSe<sub>2</sub> hot-electron devices.

Figure 2a is the optical image of the WSe<sub>2</sub> hot-electron diodes. Transfer curves of the WSe<sub>2</sub> HEPs are provided in Figure 2b, indicating obvious n-type on-off characteristics. Metal/semiconductor contact is critical for optical and electrical characteristics of Schottky diodes.<sup>16,17</sup> Figure 2c is the transfer characteristic of the obtained WSe<sub>2</sub> hot-electron transistors with different contact types. Conventional multi-layer WSe<sub>2</sub> transistors with thermally evaporated Cr/Au (15 nm/50 nm) (Cr/WSe<sub>2</sub>/Cr) have ambipolar characteristics, which can be attributed to the Fermi pinning effect.<sup>18,19</sup> The tunneling layer and transferred van der Waals Au contact (Au/WSe<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/Cr) afford an obvious n-type characteristic in this



**Figure 3.** Temperature-dependent performance and photoresponse of the WSe<sub>2</sub> HEPs. (a) Output characteristics of WSe<sub>2</sub> HEPs at different temperatures. (b) Arrhenius plot ln ( $I_{DS}/T^2$ ) versus 1000/*T* of the WSe<sub>2</sub> HEPs. (c)  $I_{DS}-V_{DS}$  curves under different incident light illuminations. (d) Photoresponse of the WSe<sub>2</sub> HEPs with different wavelengths. (e) Time-dependent dynamic photoresponse under 532 nm incident light illumination with a power intensity of 906 mW/cm<sup>2</sup>. (f) High-resolution photoresponse indicates  $\tau_{rise}$  and  $\tau_{decav}$  values.



**Figure 4.** Illumination power-dependent photoresponse. (a)  $I_{DS}-V_{DS}$  characteristics of the WSe<sub>2</sub> HEPs under 532 nm laser illumination. (b) Shortcircuit current ( $I_{SC}$ ) and open-circuit voltage ( $V_{OC}$ ) versus  $P_{light}$ . (c) Output electrical power  $P_{el}$  versus  $V_{DS}$ . (d) Output characteristic of the HEPs under light illumination. (e) Power-dependent photoresponsivity and detectivity. (f) External quantum efficiency of the WSe<sub>2</sub> hot-electron photodetector at  $V_{DS} = -1$  V.

work. Figure 2d indicates the superior rectification ratio (RR) of 10<sup>7</sup>, which is beyond the previously reported WSe<sub>2</sub>-based diode.<sup>20,21</sup> Moreover, the reverse leakage current is significantly suppressed by the Schottky junctions and tunneling layer. The output current  $(I_{DS})$  is plotted in Figure 2d. Figure 2e reveals the gate-dependent RR in the dark as a function of  $V_{\rm DS}$ . The WSe<sub>2</sub> hot-electron diode exhibits an ideality factor (n) of 1.17 (Figure S1). The dynamic rectifying characteristics are shown in Figure 2f. An evident rectified output signal is traced by a digital oscilloscope with a 100 Hz input sine waveform of a peak-to-peak value of 10 V. There is little distortion and slight voltage drop (5 V down to 4.28 V) in the output waveform. Moreover, the WSe<sub>2</sub> hot-electron diode can still normally work under a wide range of frequencies, which makes it highly promising for primary element application in 2D material-based nanoelectronics.

Figure 3a shows the output characteristics at  $V_{\rm G} = 60$  V with temperatures ranging from 100 to 280 K. According to the traditional thermionic theory,<sup>22–24</sup> as shown below

$$I_{\rm DS} = AA^*T^2 \exp\left[-\frac{q}{k_{\rm B}T}\left(\varphi_{\rm B} - \frac{V_{\rm DS}}{n}\right)\right]$$

where A is the area of the photodetector,  $A^*$  is the Richardson's constant, q is the elementary electron charge,  $k_{\rm B}$  is the Boltzmann constant, T is the temperature,  $V_{\rm DS}$  is the applied source-drain bias, and n is the ideality factor. Obviously, the on-state current increases with temperature, indicating that the thermionic emission over Schottky barrier (SB) increases with current flowing. Therefore, the dominant tunnel transport is assisted by thermionic emission.<sup>25,26</sup> Figure 3b shows the gate-dependent Arrhenius plot of the WSe<sub>2</sub> HEPs, and the calculated total barrier height of the Au/WSe<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/Cr is about 307 meV at  $V_{\rm G} = 60$  V, as shown in Figure

S2. Also, the corresponding band alignment of the HEPs with different gate bias values under light illumination is shown in Figure S3. Figure 3c is the linear output plots of the WSe<sub>2</sub> HEPs at  $V_{\rm G}$  = 60 V under illumination. The photocurrent reached the peak value with 532 nm incident light illumination (Figure 3d), which is measured with a  $P_{\text{light}}$  of 100 mW/cm<sup>2</sup>. Moreover, the on-off characteristics of WSe<sub>2</sub> HEPs are shown in Figure 3e, where the device exhibits reliable and fast on-off switching performance. Figure 3f is the high-resolution photoresponse of the HEPs, and the response  $( au_{
m rise})$  and recover ( $\tau_{decav}$ ) times are 768 and 864  $\mu$ s, respectively. Since the Al<sub>2</sub>O<sub>3</sub> tunneling barrier can screen monochromatic hot electrons with high kinetic energy, the built-in electric field in the SB contact region further affords the short response of the WSe<sub>2</sub> HEPs, as shown in Figure S4. Therefore, the WSe<sub>2</sub> HEPs present superior speed among the previously reported 2D material based photodetectors <sup>27,28</sup> material-based photodetectors.<sup>2</sup>

The power-dependent photoresponse is measured to state the photoelectric effect of Schottky-contacted WSe<sub>2</sub> HEPs. Figure 4a indicates that the photocurrent obviously increases with  $P_{\text{light}}$ . The photoinduced carriers are generated and then transported through the ultrathin Al<sub>2</sub>O<sub>3</sub> tunneling layer.<sup>29</sup> At an incident light power of 580 mW/cm<sup>2</sup>, the  $I_{\text{light}}/I_{\text{dark}}$  ratio is  $1.8 \times 10^6$ . The large  $I_{\text{light}}/I_{\text{dark}}$  value is ascribed to the thermally distributed hot carriers. In the previously reported work, photoinduced carriers were generated near the Au/WSe<sub>2</sub> junction region.<sup>15</sup> The photoinduced carriers are recombined through the WSe<sub>2</sub> layer, and thus, the previous reported works present low photoresponsivity and long response time. In contrast, the vertical heterostructure in this work broadens the carrier distribution region, leading to a high  $I_{\rm light}/I_{\rm dark}$  ratio. In Figure 4b, the short current  $(I_{SC})$  and open-circuit voltage  $(V_{\rm OC})$  simultaneously increase with  $P_{\rm light}$ . By fitting as  $I_{\rm SC}$  =  $AP_{\text{light}}^{\theta}$ , the HEPs present an ideal  $\theta$  value of 1.01, indicating the high quality of the interfaces.<sup>30,31</sup> Figure 4c is the output electrical power  $(P_{el})$  versus  $V_{DS}$  with varied incident light density. With a continuous shift of  $I_{\rm DS} - V_{\rm DS}$  characteristics, the peak  $P_{el}$  is increased with  $P_{light}$ . The maximum output of electrical power  $(P_{max})$  is indicated in Figure 4d, and a typical  $P_{\text{max}} = 0.15 \,\mu\text{W}$  is obtained. Also, the fill factor (FF) and power conversion efficiency (PCE) are 0.68 and 16.1%, which are obtained with  $P_{\text{light}} = 576 \text{ mW/cm}^2$ , respectively. Figure S5 is the power-dependent FF and PCE, and both FF and PCE decrease with  $P_{\text{light}}$ . As shown in Figure 4e, both R and  $D^*$ decrease with P<sub>light</sub>. Based on the measured low-frequency noise in Figure S6, a high R of 3.69 A/W and D\* of 2.39  $\times$  $10^{13}$  Jones are simultaneously obtained at an ultralow  $P_{\text{light}} =$ 5.0  $\mu$ W/cm<sup>2</sup>, which is superior to those of the previously reported works.<sup>32-34</sup> Although the scattering of photoinduced electrons would degrade the responsivity with high incident power, due to the dominant hot electron transformation mechanism of the photodetectors, negligible changes of responsivity are observed when  $P_{\text{light}}$  is above 1 mW/cm<sup>2</sup>, which is superior to previously reported devices.<sup>35,36</sup> As shown in Figure S7, the HEPs present a high signal-to-noise ratio above 10<sup>5</sup> as well as desirable linear dynamic range (LDR) values. The external quantum efficiency (EQE) decreases with  $P_{\text{light}}$  and reaches a peak value of 859%, as shown in Figure 4f. The built-in field in Schottky junctions facilitates the injected photoinduced electron transportation in WSe<sub>2</sub>, and the applied voltage pulls out the electrons in WSe2, leading to an increased photocurrent, and this affords the high EQE. Photogain (G) is calculated to be 5.8, which further indicates that the

photoinduced carriers circulate several times before recombination.

## CONCLUSIONS

In summary, Schottky-contacted WSe<sub>2</sub> HEPs with ultrahigh sensitivity and fast response are developed. The hot electrons promise ultrasensitive response to incident light, and the builtin electric field in Schottky barriers at the contact region spontaneously and rapidly separates the photoinduced carriers before they lose their excess energy. Therefore, the photodetectors present fast response speed even under weak incident light. Photoinduced hot electrons in WSe<sub>2</sub> are transported by tunneling, leading to a high rectification ratio. Also, the reverse leakage current is suppressed to 1 pA/ $\mu$ m by the large depletion region width of the Schottky barrier. This work presents an alternative strategy for developing ultrasensitive and fast future electronic and optoelectronic devices.

## METHODS

**Device Fabrication.** Cr/Au electrodes were deposited on a silicon substrate with a 300 nm SiO<sub>2</sub> layer using conventional photolithography followed by thermal evaporation. Then, WSe2 flakes were peeled with Scotch tape and transferred onto a Cr/Au electrode to form ideal Schottky contact without the pinning effect. After that, a 5 nm  $Al_2O_3$  tunneling layer was grown by atomic layer deposition (ALD). The growth rate is 1.0 Å per cycle as follows: Trimethylaluminum (TMA) is used as a precursor source, while the H<sub>2</sub>O source was kept at room temperature. The flow rate of the Ar carrier gas was 50 sccm. The pulse times for TMA and H<sub>2</sub>O are 0.1 and 0.4 s, and the post-purge times are 12 and 18 s, respectively; subsequently, the copolymer (MMA) was spin-coated at a speed of 3000 rpm and baked on a hot plate at 150 °C for 1 min, and then polymethyl methacrylate (PMMA, 495k) was spin-coated at 3000 rpm and baked at 150 °C for 5 min. Finally, the top Cr/ Au (15 nm/50 nm) electrode was fabricated by EBL, e-beam evaporation, and lift-off processes.

**Material Characterization and Device Measurement.** Optical images were obtained by an Olympus BX53, and the thickness of  $Al_2O_3$  and  $WSe_2$  with the corresponding AFM image was obtained on a Park XE7. EBL was carried out on a Raith pattern generator and SEM combination. Electrical measurements were carried out by employing a Lake Shore TTPX probe station and Agilent B1500A semiconductor parameter analyzer. The light sources were lasers with wavelengths of 375, 457, 532, 660, 808, and 914 nm, respectively.

# ASSOCIATED CONTENT

#### Supporting Information

The Supporting Information is available free of charge at https://pubs.acs.org/doi/10.1021/acsphotonics.1c01256.

Ideality factor of the WSe<sub>2</sub> diode; extracted SB height of the hot-electron device; band diagram of the WSe<sub>2</sub> hotelectron diode under different gate voltages; comparison of the rectification behavior and photoresponse without and with the  $Al_2O_3$  layer; light power-dependent FF and PCE; low-frequency noise of the hot-electron devices; and extracted SNR and LDR values of the WSe<sub>2</sub> hotelectron photodetectors (PDF)

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#### **Author Contributions**

L.L. and X.L. conceived and designed the experiments. M.Z. and X.D. prepared the samples and finished related tests and data analysis. M.Z. and X.L. wrote the manuscript. S.Z. and C.L. finished the 3D drawing design. D.W., G.L., Z.X., and Z.F. present the suggestions for improving the quality of this work and revised the manuscript. Related tests and result analysis

were done by M.Z. using protocols provided by L.L. All authors examined and commented on the manuscript.

## Notes

The authors declare no competing financial interest.

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